Ultra Field Stop IGBT, 1200 V, 60 A

FGY60T120SQDN

General Description

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Ultra Field Stop Trench construction, and provides superior performance in demanding switching applications, offering both low on-state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

Features

- Extremely Efficient Trench with Field Stop Technology
- Maximum Junction Temperature $T_J = 175^{\circ}C$
- Low Saturation Voltage: $V_{CE(sat)} = 1.7 \text{ V} (Typ.) @ I_C = 60 \text{ A}$
- 100% of the Parts Tested for I_{LM} (Note 1)
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- RoHS Compliant

Applications

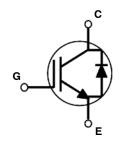
• Solar Inverter, UPS

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)						
Symbol	Description	Value	Unit			
V _{CES}	Collector to Emitter Voltage	1200	V			
V _{GES}	Gate to Emitter Voltage	±25	V			
	Transient Gate to Emitter Voltage	±30	V			
Ι _C	Collector Current @ ($T_C = 25^{\circ}C$)	120	А			
	Collector Current @ (T _C = 100°C)	60	А			
I _{LM} (1)	Pulsed Collector Current @ (T _C = 25°C)	240	А			
I _{CM} (2)	Pulsed Collector Current	240	А			
١ _F	Diode Forward Current @ ($T_C = 25^{\circ}C$)	120	А			
	Diode Forward Current @ (T _C =100°C)	60	А			
I _{FM}	Pulsed Diode Max. Forward Current	240	А			
PD	Maximum Power Dissipation	517	W			
	@ (T _C = 25°C) @ (T _C =100°C)	259	W			
TJ	Operating Junction Temperature	–55 to +175	°C			
T _{stg}	Storage Temperature Range	–55 to +175	°C			
TL	Maximum Lead Temp. For soldering Purposes, 1/8" from case for 5 seconds	300	°C			



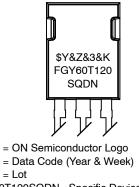
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MARKING DIAGRAM



FGY60T120SQDN= Specific Device Code

&Y

&3 &K

ORDERING INFORMATION

See detailed ordering and shipping information on page 3 of this data sheet.

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. VCC = 800 V, V_{GE} = 15 V, I_C = 240 A, \dot{R}_{G} = 68 Ω , Inductive Load

2. Repetitive rating: Pulse width limited by max. Junction temperature

THERMAL CHARACTERISTICS

Symbol	Parameter	FGY60T120SQDN	Unit
R _{0JC} (IGBT)	Thermal Resistance, Junction to Case, Max.	0.29	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	0.42	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25° C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
OFF CHARA	ACTERISTICS					
BV _{CES}	Collector to Emitter Breakdown Voltage	V_{GE} = 0V, I _C = 500 μ A	1200	-	-	V
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	400	μΑ
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±200	nA
ON CHARAC	CTERISTICS					
V _{GE(th)}	G-E Threshold Voltage	I_C = 400 μ A, V_{CE} = V_{GE}	4.5	5.5	6.5	V
		I _C = 60 A _, V _{GE} = 15 V	-	1.7	1.95	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	$I_{C} = 60 \text{ A}, V_{GE} = 15 \text{ V}, T_{C} = 175^{\circ}\text{C}$	_	2.3	-	v
	HARACTERISTICS		+	4		1
C _{ies}	Input Capacitance		-	7147	-	pF
C _{oes}	Output Capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	-	203	-	pF
C _{res}	Reverse Transfer Capacitance		-	114	-	pF
SWITCHING	CHARACTERISTICS	•				
t _{d(on)}	Turn-On Delay Time		-	52	-	ns
t _r	Rise Time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 60 \text{ A}, \text{ R}_{G} = 10 \Omega,$	-	84	-	ns
td(off)	Turn-Off Delay Time	V _{GE} = 15 V,	-	296	-	ns
t _f	Fall Time	Inductive Load, T _C = 25°C	-	56	-	ns
Eon	Turn-On Switching Loss		-	5.15	-	mJ
Eoff	Turn–Off Switching Loss		-	1.82	-	mJ
Ets	Total Switching Loss		-	6.97	-	mJ
td(on)	Turn-On Delay Time		-	40	-	ns
tr	Rise Time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 60 \text{ A}, \text{ R}_{G} = 10 \Omega,$	-	72	-	ns
td(off)	Turn-Off Delay Time	V _{GE} = 15 V,	-	324	-	ns
t _f	Fall Time	Inductive Load, T _C = 175°C	-	144	-	ns
Eon	Turn-On Switching Loss		-	7.18	-	mJ
Eoff	Turn-Off Switching Loss		-	3.1	-	mJ
Ets	Total Switching Loss		-	10.28	-	mJ
Qg	Total Gate Charge		-	311	-	nC
Qge	Gate to Emitter Charge	$V_{CE} = 600 \text{ V}, \text{ I}_{C} = 60 \text{ A}, \text{ V}_{GE} = 15 \text{ V}$	_	57	-	nC
Qgc	Gate to Collector Charge	1	-	153	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_C = 25° C unless otherwise noted)

Symbol	Parameter	Test Condition		Min.	Тур.	Max.	Unit
			T _C = 25°C	-	3.4	4	
V _{FM}	Diode Forward Voltage		T _C = 175°C	-	3.2	-	V
t _{rr}		$T_{C} = 25^{\circ}C$ $T_{C} = 175^{\circ}C$ $T_{C} = 25^{\circ}C$	T _C = 25°C	-	91	-	ns
	Diode Reverse Recovery Time		T _C = 175°C	-	309	-	
Q _{rr}	Diada Davara Daarway Ohama		T _C = 25°C	_	860	-	nC
	Diode Reverse Recovery Charge		T _C = 175°C	-	4902	-	
I _{rrm}	Diode Reverse Recovery Current		T _C = 25°C	_	19	_	А
			T _C = 175°C	-	32	-	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Quantity
FGY60T120SQDN	FGY60T120SQDN	TO-247-3LD (Pb-Free)	30/Tube

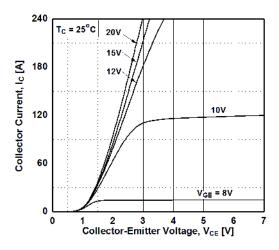


Figure 1. Typical Output Characteristics

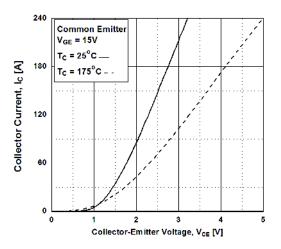


Figure 3. Typical Saturation Voltage Characteristics

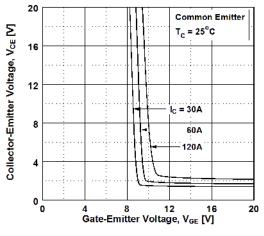


Figure 5. Saturation Voltage vs. V_{GE}

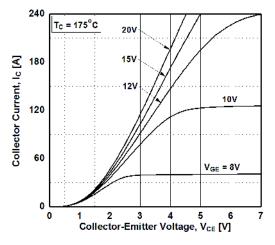


Figure 2. Typical Output Characteristics

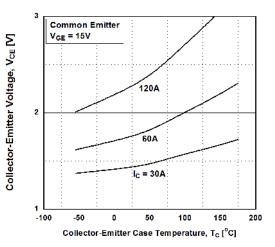


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

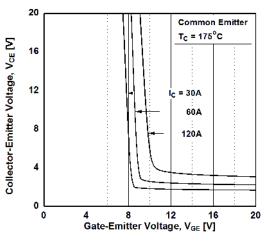
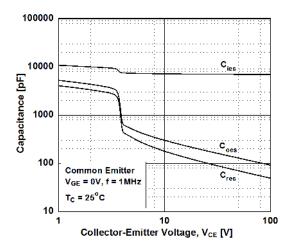


Figure 6. Saturation Voltage vs. V_{GE}





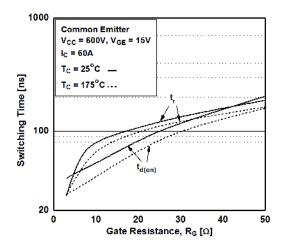


Figure 9. Turn-on Characteristics vs. Gate Resistance

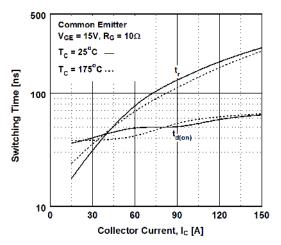


Figure 11. Turn-on Characteristics vs. Collector Current

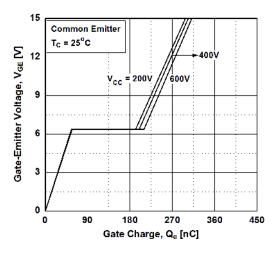


Figure 8. Gate charge Characteristics

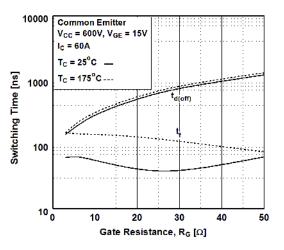


Figure 10. Turn-off Characteristics vs. Gate Resistance

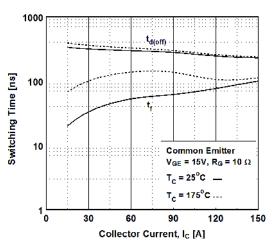
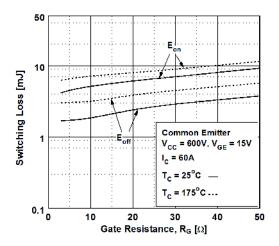
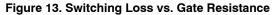


Figure 12. Turn-off Characteristics vs. Collector Current





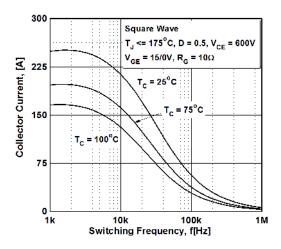


Figure 15. Load Current vs. Frequency

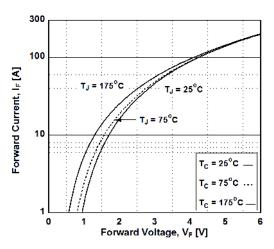


Figure 17. Forward Characteristics

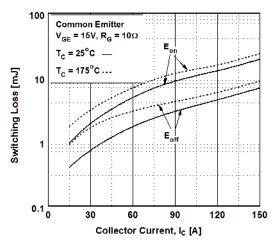
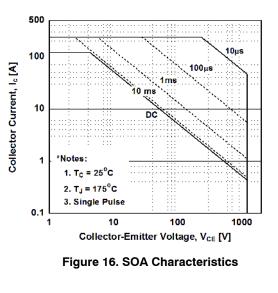


Figure 14. Switching Loss vs. Collector Current



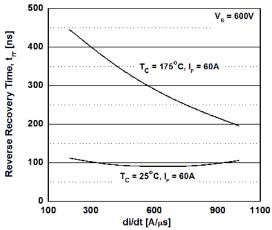


Figure 18. Reverse Recovery Time vs. di_F/dt

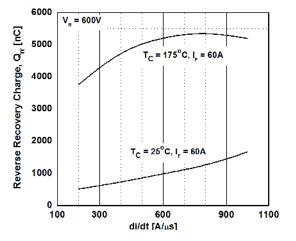


Figure 19. Reverse Recovery Charge vs. di_F/dt

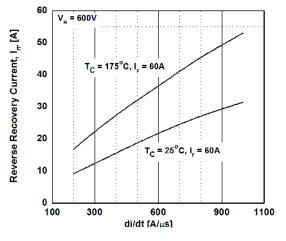


Figure 20. Reverse Recovery Current vs. di_F/dt

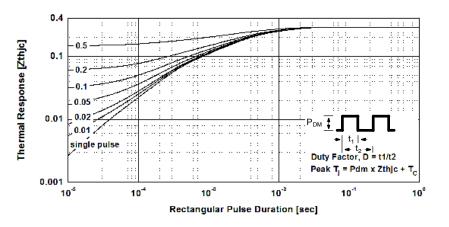


Figure 21. Transient Thermal Impedance if IGBT

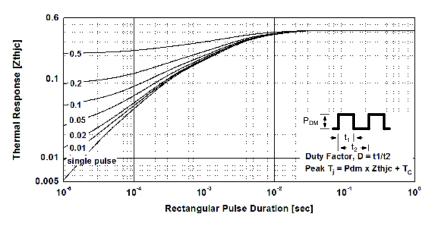
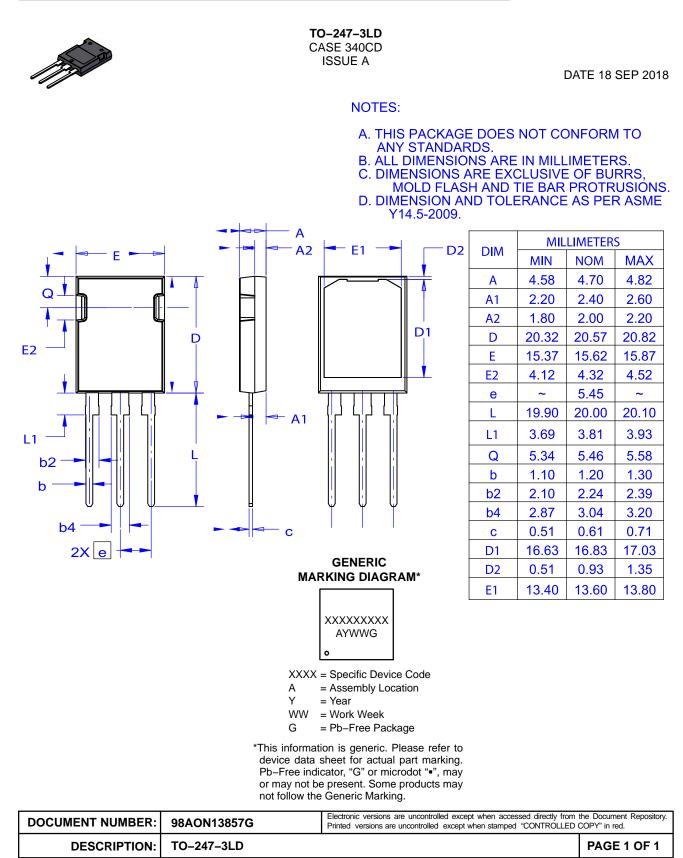


Figure 22. Transient Thermal Impedance if Diode





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